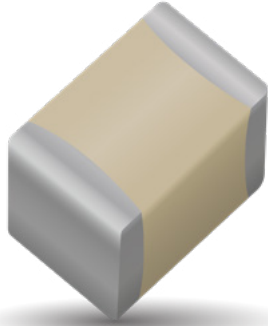


RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

100B Series Porcelain Superchip® Multilayer Capacitors



FEATURES

- Case B Size (.110" x .110")
- Capacitance Range 0.1pF to 1000pF
- Extended WVDC up to 1500 VDC
- Low ESR/ESL
- High Q
- Low Noise
- Ultra-Stable Performance
- High Self-Resonance
- Established Reliability (QPL)

GENERAL DESCRIPTION

KYOCERA AVX, the industry leader, offers new improved ESR/ESL performance for the 100 B Series RF/Microwave Capacitors. This Series is now available with extended operating temperatures up to 175°C. High Density porcelain construction provides a rugged, hermetic package.

FUNCTIONAL APPLICATIONS

- Bypass
- Impedance Matching
- Coupling
- DC Blocking
- Tuning

CIRCUIT APPLICATIONS

- UHF/Microwave RF Power Amplifiers
- Low Noise Amplifiers
- Oscillators
- Filter Networks
- Timing Circuits

ENVIRONMENTAL CHARACTERISTICS

Thermal Shock	Mil-STD-202, Method 107, Condition A
Moisture Resistance	Mil-STD-202, Method 106
Low Voltage Humidity	Mil-STD-202, Method 103, condition A, with 1.5 VDC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours
Life Test	MIL-STD-202, Method 108, for 2000 hours, at 125°C. Voltage applied. 200% of WVDC for capacitors rated at 500 volts DC or less. 120% of WVDC for capacitors rated at 1250 volts DC or less. 100% of WVDC for capacitors rated above 1250 volts DC
Termination Styles	Available in various surface mount and leaded styles. See Mechanical Configurations
Terminal Strength	Terminations for chips and pellets withstand a pull of 5 lbs. min., 15 lbs. typical, for 5 seconds in direction perpendicular to the termination surface of the capacitor.

PACKAGING OPTIONS



Tape & Reel



Vertical
Orientation
Tape & Reel



Cap Pac®
(100 pcs)



ELECTRICAL SPECIFICATIONS

Temperature Coefficient (TCC)	+90 ±20 PPM/°C (-55°C to +125°C) +90 ±30 PPM/°C (+125°C to +175°C)
Capacitance Range	0.1pF to 1000pF
Operating Temperature	-55°C to +125°C*
Quality Factor	greater than 10,000 at 1 MHz
Insulation Resistance (IR)	0.1 pF to 470 pF: 10 ⁶ Megohms min. @ +25°C at rated WVDC. 10 ⁵ Megohms min. @ +125°C at rated WVDC. 510 pF to 1000 pF: 10 ⁵ Megohms min. @ +25°C at rated WVDC. 10 ⁴ Megohms min. @ +125°C at rated WVDC.
Working Voltage (WVDC)	See Capacitance Values table
Dielectric Withstanding Voltage (DWV)	250% of WVDC for capacitors rated at 500 volts DC or less for 5 seconds. 150% of WVDC for capacitors rated at 1250 volts DC or less for 5 seconds. 120% of WVDC for capacitors rated above 1250 Volts DC for 5 seconds
Aging Effects	None
Piezoelectric Effects	None
Capacitance Drift	± (0.02% or 0.02 pF), whichever is greater
Retrace	Less than ±(0.02% or 0.02 pF), whichever is greater.

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CAPACITANCE VALUES

Cap. Code	Cap. (pF)	Tol.	Rated WVDC		Cap. Code	Cap. (pF)	Tol.	Rated WVDC		Cap. Code	Cap. (pF)	Tol.	Rated WVDC		CAP CODE	CAP. (pF)	TOL.	RATED WVDC					
			STD.	EXT.				STD.	EXT.				STD.	EXT.				STD.	EXT.				
0R1	0.1	B	500	1500	2R4	2.4	B, C, D	500	1500	200	20	F, G, J, K, M	500	1500	151	150	300	EXT.	1000				
0R2	0.2				2R7	2.7				220	22				161	160							
0R3	0.3	B, C			3R0	3.0				240	24				181	180							
0R4	0.4				3R3	3.3				270	27				201	200							
0R5	0.5	B, C, D			3R6	3.6				300	30				221	220	200	EXT.	600				
0R6	0.6				3R9	3.9				330	33				241	240							
0R7	0.7				4R3	4.3				360	36				271	270							
0R8	0.8				4R7	4.7				390	39				301	300							
0R9	0.9				5R1	5.1				430	43				331	330	100	EXT.	300				
1R0	1.0				5R6	5.6				470	47				361	360							
1R1	1.31				6R2	6.2				510	51				391	390							
1R2	1.2				6R8	6.8	560			56	431				430								
1R3	1.3				7R5	7.5	620			62	471				470	50	EXT.	300					
1R4	1.4				8R2	8.2	680			68	511				510								
1R5	1.5				9R1	9.1	750			75	561				560								
1R6	1.6	F, G, J, K, M			100	10	F, G, J, K, M			820	82				621	620	50	EXT.	300				
1R7	1.7				110	11				910	91				681	680							
1R8	1.8				120	12				101	100				751	750							
1R9	1.9				130	13				111	110				821	820							
2R0	2.0				150	15				121	120		300	1000	911	910	50	EXT.	300				
2R1	2.1				160	16				131	130				102	1000							
2R2	2.2				180	18																	

VRMS = 0.707 X WVDC

• SPECIAL VALUES, TOLERANCES, DIFFERENT WVDC AND MATCHING AVAILABLE. • ENCAPSULATION OPTION AVAILABLE. PLEASE CONSULT FACTORY.NOTE: EXTENDED WVDC DOES NOT APPLY TO CDR PRODUCTS.

HOW TO ORDER

100

B

910

J

W

500

X

T

Packaging

T = Tape and Reel, 500 pc qty
TV = Vertical Tape and Reel, 500 pc qty
Please see last column of mechanical configuration table for other options.

Laser Marking (Optional)

Voltage Rating

Termination Style Code

Please see 2nd Column Mechanical Configuration Table

Series ———

Case Size ———

See mechanical dimensions below

Capacitance ———

EIA Capacitance Code in pF.
First two digits = significant figures or "R" for decimal place.
Third digit = number of zeros or after "R" significant figures

Capacitance Tolerance Code ———

Code	B	C	D	F	G	J	K	M
Tol.	±1 pF	±25 pF	±5 pF	±1%	±2%	±5%	±10%	±20%

The above part number refers to a 100 B Series (case size B) 91 pF capacitor, J tolerance (±5%), 500 WVDC, with W termination (Tin /Lead, Solder Plated over Nickel Barrier), laser marking and Tape and Reel packaging.

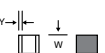
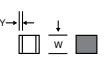
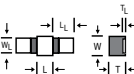
RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

100B Series Porcelain Superchip® Multilayer Capacitors



MECHANICAL CONFIGURATION

Series & Case Size	Term. Code	MIL-PRF-55681	Case Size & Type	Outline W/T is a Termination Surface	Body Dimensions inches (mm)			Lead and Termination Dimensions and Material			Pkg Type	Pkg Code	
					Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials				
100B	W	CDR14BG	 Solder Plate		.110+ .020 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59) max.	.015 (0.38) ±.010 (0.25)	Tin / Lead, Solder Plated over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	P	CDR14BG	 Pellet		.110+ .035 - .01 (2.79 + 0.89-0.25)	.110 ±.015 (2.79 ±0.38)			Heavy Tin/Lead Coated, over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	T	N/A	 Solderable Nickel		.110+ .035 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			RoHS Compliant Tin Plated over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	CA	CDR13BG	 Gold Chip		.110+ .020 - .010 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			RoHS Compliant Gold Plated over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	MS	CDR21BG	 Microstrip		.135 ±.015 (3.43 ±0.38)	.110 ±.015 (2.79 ±0.38)	.120 (3.05) max.	N/A	Length (L _L)	Width (W _L)	Thickness (T _L)	Cap Pac, 20 pcs	C20
100B	AR	CDR22BG	 Axial Ribbon				.102 (2.59) max.		.250 (6.35) min.	.093±.005 (2.36 ±0.13)	.004 ± .001 (.102±.025)	Box, 20 or 100 pcs	B20 or B100
100B	RR	CDR24BG	 Radial Ribbon									Box, 20 or 100 pcs	B20 or B100
100B	RW	CDR23BG	 Radial Wire				.145 ±.020 (3.68 ±0.51)			.500 (12.7)	#26 AWG., .016 (.406) dia. nominal	Box, 20 or 100 pcs	B20 or B100
100B	AW	CDR25BG	 Axial Wire		Box, 20 or 100 pcs							B20 or B100	

Additional lead styles available: Narrow Microstrip (NM), Narrow Axial Ribbon (NA) and Vertical Narrow Microstrip (H). Other lead lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are **RoHS** compliant.

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NON-MAGNETIC MECHANICAL CONFIGURATION

Series & Case Size	Term. Code	MIL-PRF-55681	Case Size & Type	Outline W/T is a Termination Surface	Body Dimensions inches (mm)			Lead and Termination Dimensions and Material			Pkg Type	Pkg Code			
					Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials						
100B	WN	Meets Requirements	 Non-Mag		.110+ .020 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59) max.	.015 (0.38) ±.010 (0.25)	Tin / Lead, Solder Plated over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100		
100B	PN	Meets Requirements	 Solderable Nickel		.110+ .035 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			Heavy Tin / Lead, Coated over Non-Magnetic Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100		
100B	TN	Meets Requirements	 Non-Mag Solderable Barrier		.110+.020 - .010 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			RoHS Compliant Tin Plated over Non-Magnetic Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100		
100B	MN	Meets Requirements	 Microstrip		.135 ±.015 (3.43 ±0.38)	.110 ±.015 (2.79 ±0.38)	.120 (3.05) max.	N/A	Length (L _L)	Width (W _L)	Thickness (T _L)	Cap Pac, 20 pcs	C20		
100B	AN	Meets Requirements	 Axial Ribbon				.102 (2.59) max.		.250 (6.35) (6.35) min.	.093±.005 (2.36 ±0.13)	.004 ± .001 (.102±.025)	Box, 20 or 100 pcs	B20 or B100		
100B	FN	Meets Requirements	 Radial Ribbon									Box, 20 or 100 pcs	B20 or B100		
100B	RN	Meets Requirements	 Radial Wire		.145 ±.020 (3.68 ±0.51)										
100B	BN	Meets Requirements	 Axial Wire						.500 (12.7)	#26 AWG., .016 (.406) dia. nominal		Box, 20 or 100 pcs	B20 or B100		

Additional lead styles available: Narrow Microstrip (NM), Narrow Axial Ribbon (NA) and Vertical Narrow Microstrip (H). Other lead lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are **RoHS** compliant.

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SUGGESTED MOUNTING PAD DIMENSIONS

Horizontal Electrode Orientation

Vertical Electrode Orientation

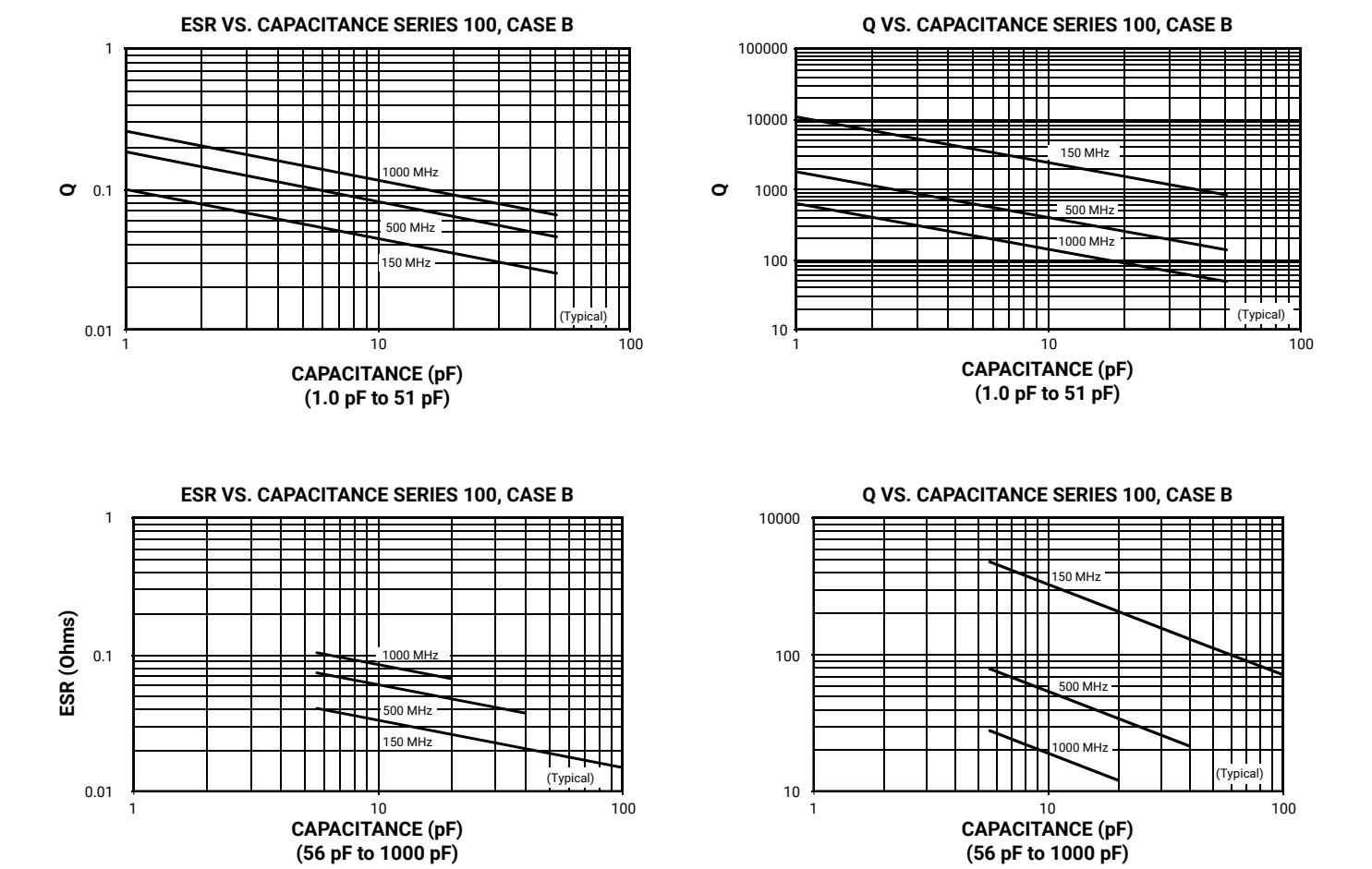
Case B Vertical Mount

Cap Value	Pad Size	A Min.	B Min.	C Min.	D Min.
0.1 pF	Normal	.065	.050	.075	.175
	High Density	.045	.030	.075	.135
0.2 pF	Normal	.090	.050	.075	.175
	High Density	.070	.030	.075	.135
0.3 to 510 pF	Normal	.110	.050	.075	.175
	High Density	.090	.030	.075	.135
> 510 pF	Normal	.120	.050	.075	.175
	High Density	.100	.030	.075	.135

Horizontal Mount

All Values	Pad Size	A Min.	B Min.	C Min.	D Min.
All Values	Normal	.130	.050	.075	.175
	High Density	.110	.030	.075	.135

PERFORMANCE DATA

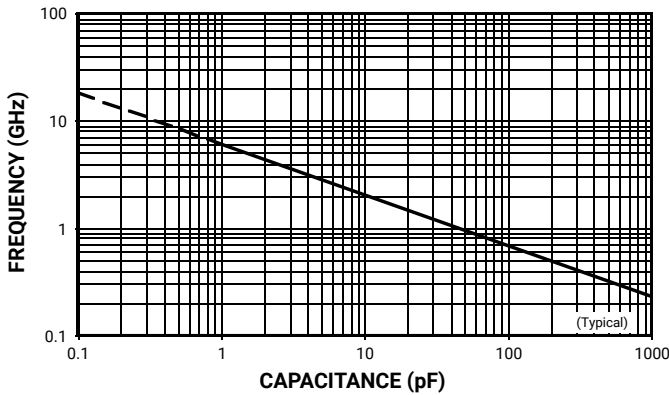


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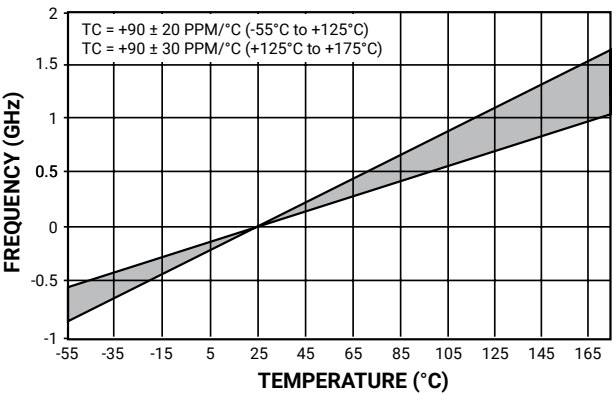


PERFORMANCE DATA

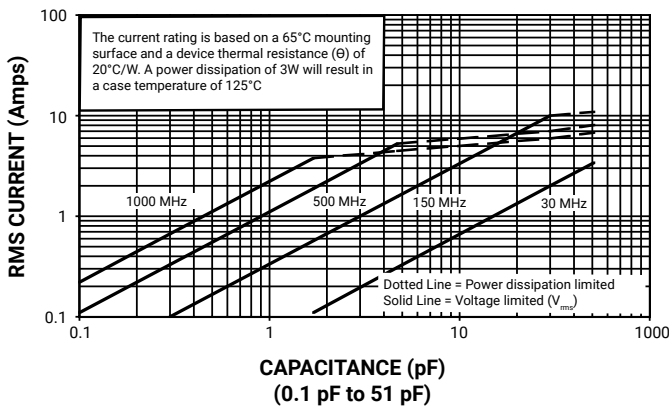
SERIES RESONANCE VS. CAPACITANCE
SERIES 100, CASE B



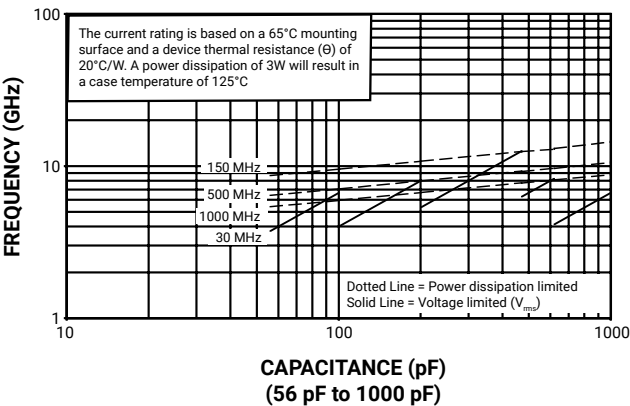
CAPACITANCE CHANGE VS. TEMPERATURE
SERIES 100, CASE B



CURRENT RATING VS. CAPACITANCE
SERIES 100, CASE B

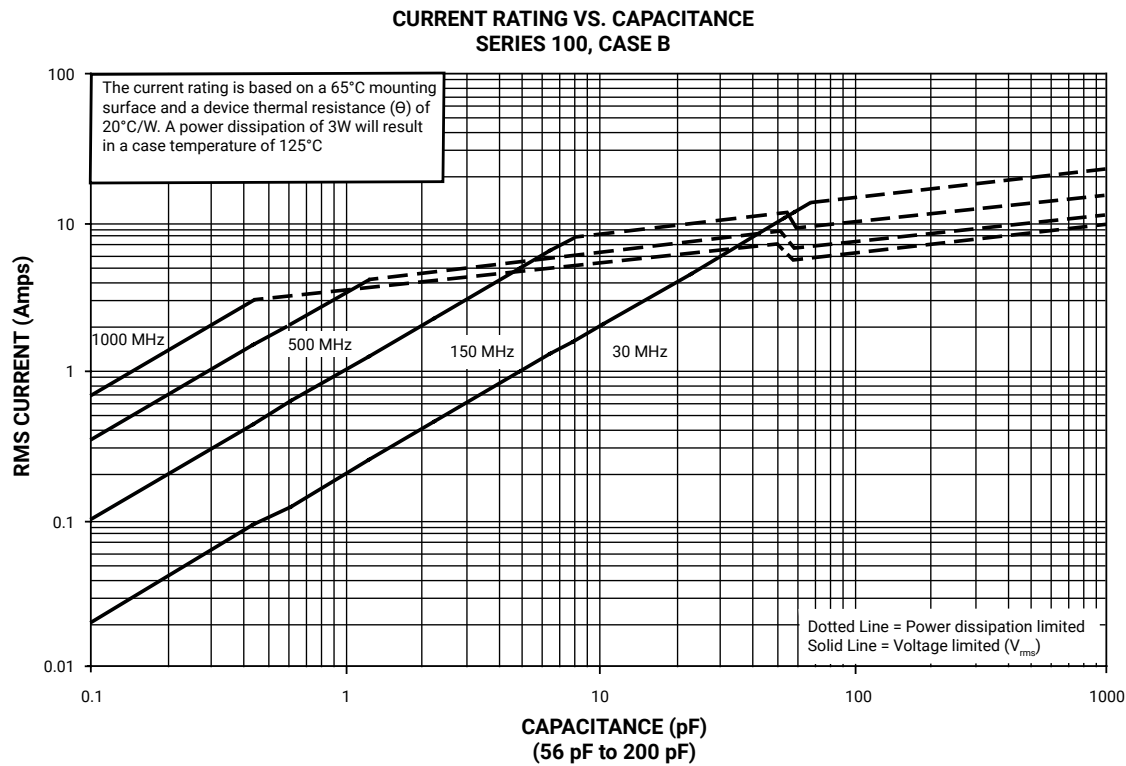


CURRENT RATING VS. CAPACITANCE
SERIES 100, CASE B



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PERFORMANCE DATA



DESIGN KITS

Kit #	RoHS Compliant	Item #	Description	Cap. Value Range (pF)	Cap. Value (pF)	Tol. (pF)	Price
Kit 9		DK0009	100B Porcelain Superchip®, 16 different values, 15 pcs. min. per value	0.1 to 2.0	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100	±5%	\$180.00
Kit 9T		DK0009T					
Kit 10		DK0010	100B Porcelain Superchip®, 16 different values, 15 pcs. min. per value	10 to 27	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470.....	±5%	\$180.00
Kit 10T		DK0010T			560, 680, 820, 1000.....	±5%	

For Online Kit Orders, Catalog & Application Notes, Visit: www.avx.com